## Evaluates: MAX14430–MAX14432

### **General Description**

The MAX14430-MAX14432 evaluation kit (EV kit) provides a proven design to evaluate the MAX14430-MAX14432 four-channel unidirectional digital isolators. Three types of evaluation boards are available to support different channel direction configurations of the MAX14430-MAX14432 family. All evaluation boards support the narrow-body 16-pin SOIC package type. See Table 1 for EV kit options.

The EV kit should be powered from two independent isolated power supplies with nominal output voltage in range from 1.71V to 5.5V. For evaluating the electrical parameters of the device without any isolation between the two sides, a single power supply can also be used.

The MAX14430FSEVKIT# comes populated with a MAX14430FASE+, but can also be used to evaluate the following digital isolators:

MAX14430BASE+

MAX14430CASE+

MAX14430EASE+

The MAX14431FSEVKIT# comes populated with the MAX14431FASE+, but can also be used to evaluate the following digital isolators:

MAX14431BASE+, MAX14431CASE+

MAX14431EASE+, MAX14431RASE+

MAX14431SASE+, MAX14431UASE+,

MAX14431VASE+

The MAX14432FSEVKIT# comes populated with the MAX14432FASE+, but can also be used to evaluate the following digital isolators:

MAX14432BASE+

MAX14432CASE+

MAX14432EASE+

The MAX14430EAEE+ and MAX14431CAEE+ have the same functionality and electrical performance as the MAX14430EASE+ and MAX14431CASE+, but in a 16-QSOP package. The MAX14432FSEVKIT# can be used to evaluate the electrical performance of the MAX14430EAEE+ and MAX14431CAEE+ with the MAX14430EASE+ or MAX14431CASE+ installed as U1.

#### **Features**

- Broad Range of Data Transfer Rates (from DC to 200Mbps)
- Four Unidirectional Channels with 3 Different Channel Direction Configurations
- SMA Connectors for Easy Connection to External Equipment
- Wide Power Supply Voltage Range from 1.71V to 5.5V
- Guaranteed Up to 3.75kV<sub>RMS</sub> Isolation for the Narrow-Body SOIC Package for 60s

Ordering Information appears at end of data sheet.

#### Table 1. EV Kit Options

EVKITPARTNUMBER	TARGET DEVICE	PACKAGE TYPE	COMMENT
MAX14430FSEVKIT#	MAX14430FASE+	16-SOIC narrow-body	200Mbps IC populated
MAX14431FSEVKIT#	MAX14431FASE+	16-SOIC narrow-body	200Mbps IC populated
MAX14432FSEVKIT#	MAX14432FASE+	16-SOIC narrow-body	200Mbps IC populated



# Evaluates: MAX14430-MAX14432

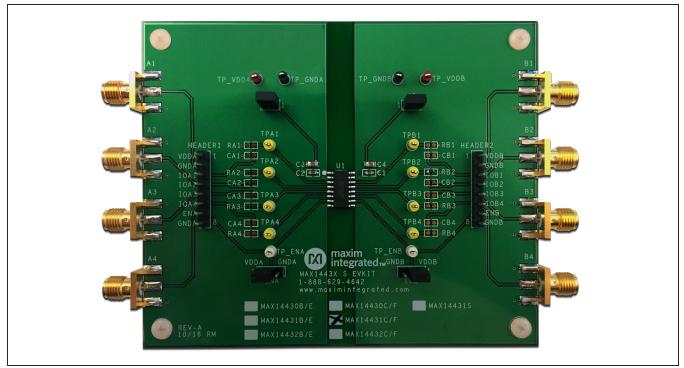


Figure 1. Narrow-Body MAX14431FSEVKIT#

## Evaluates: MAX14430–MAX14432

### **Quick Start**

#### **Required Equipment**

- MAX14430FS, MAX14431FS, or MAX14432FS EV kit
- Two DC power supplies with output range of 1.71V to 5.5V
- Signal/function generator
- Oscilloscope

#### Procedure

The MAX14430FS, MAX14431FS, and MAX14432FS EV kits are fully assembled and ready for evaluation. For manual verification follow the steps below to verify board functionality:

- 1) Verify jumper settings. See Table 2 for all shunt positions.
  - J1 and J2 are closed.
  - Jumper ENA is either in 1-2 position if U1 ENA (pin 7) has active-high polarity, or in 2-3 position if U1 ENA (pin 7) has active-low polarity.
  - Jumper ENB is in 1-2 position.

- Connect one DC power supply between the EV kit's TP\_VDDA and TP\_GNDA test points; connect the other DC power supply between TP\_VDDB and TP\_ GNDB test points.
- Set both DC power supply outputs between 1.71V and 5.5V, and then enable the power supply outputs. *Note:* It is also possible to power the EV kits from a single power supply to test electrical parameters but this invalidates the digital isolation of the IC.
- Connect the signal/function generator to the SMA connector or test point of side A and observe the isolated signal on the corresponding side B output, using an oscilloscope.

### Table 2. MAX1443XS EV Kits Board Connectors and Shunt Positions

CONNECTOR SHUNT POSITION		DESCRIPTION			
	SIDE A				
	1	Test point or input header for V <sub>DDA</sub>			
	2	Test point or input header for GNDA			
	3	Test point or input header for I/O; same as A1 SMA			
HEADER1	4	Test point or input header for I/O; same as A2 SMA			
I NEADER I	5	Test point or input header for I/O; same as A3 SMA			
	6	Test point or input header for I/O; same as A4 SMA			
	7	Test point or input header for side A enable; same as ENA jumper pin 2			
	8	Test point or input header for GNDA			
A1 (SMA) n/a I/O on side A		I/O on side A			
A2 (SMA) n/a I/O o		I/O on side A			
A3 (SMA) n/a I/O on side A		I/O on side A			
A4 (SMA)	A4 (SMA) n/a I/O on side A				
J1	Open	Use current meter to measure current of side A			
JI	1-2*	Connect power supply to V <sub>DDA</sub>			
ENA	1-2*	Connect side A enable pin to $V_{DDA}$ ; side A outputs are enabled if ENA is active-high or high-impedance if active-low. Default setting on EV kits			
	2-3	Connect side A enable pin to GNDA; side A outputs are high-impedance if ENA is active- high or enabled if active-low.			

# Evaluates: MAX14430-MAX14432

CONNECTOR SHUNT POSITION		DESCRIPTION			
	SIDE B				
	1	Test point or input header for V <sub>DDB</sub>			
	2	Test point or input header for GNDB			
	3	Test point or input header for I/O; same as B1 SMA			
HEADER2	4	Test point or input header for I/O; same as B2 SMA			
HEADER2	5	Test point or input header for I/O; same as B3 SMA			
	6	Test point or input header for I/O; same as B4 SMA			
	7	Test point or input header for side B enable; same as ENB jumper pin 2			
	8	Test point or input header for GNDB			
B1 (SMA) n/a I/O on side B		I/O on side B			
B2 (SMA)	n/a	I/O on side B			
B3 (SMA)	B3 (SMA) n/a I/O on side B				
B4 (SMA)	B4 (SMA) n/a I/O on side B				
J2	Open	Use current meter to measure current of side B			
	1-2*	Connect power supply to V <sub>DDB</sub>			
	1-2*	Connect side B enable pin to V <sub>DDB</sub> ; side B outputs are enabled. Default setting on EV kits			
ENB	2-3	Connect side B enable pin to GNDB; side B outputs are high-impedance.			

# Table 2. MAX1443XS EV Kits Board Connectors and Shunt Positions (continued)

\*Default configuration

### **Table 3. EV Kits Test Points**

TEST POINT	DESCRIPTION				
	SIDE A				
TP_VDDA	Test point for V <sub>DDA</sub>				
TP_GNDA	Test point for GNDA				
TPA1	Test point for SMA connector A1				
TPA2	Test point for SMA connector A2				
TPA3	Test point for SMA connector A3				
TPA4	Test point for SMA connector A4				
TP_ENA	Test point for jumper ENA pin 2				
	SIDE B				
TP_VDDB	Test point for V <sub>DDB</sub>				
TP_GNDB	Test point for GNDB				
TPB1	Test point for SMA connector B1				
TPB2	Test point for SMA connector B2				
TPB3	Test point for SMA connector B3				
TPB4	Test point for SMA connector B4				
TP_ENB	Test point for jumper ENB pin 2				

### **Detailed Description of Hardware**

The EV kits are powered from two power supplies as described below.

#### **External Power Supplies**

Power to the MAX14430FS, MAX14431FS, and MAX14432FS EV kits are derived from two external sources which can both be between +1.71V and +5.5V. Connect one source between the  $V_{DDA}$  and GNDA test points, and the other source between the  $V_{DDB}$  and GNDB test points. Each supply can be set independently and can be present over the entire range from 1.71V to 5.5V, regardless of the level or presence of the other supply. The MAX14430–MAX14432 level-shift the data, transmitting them across the isolation barrier.

Four SMA connectors on each side of the board allow easy connections to signal generator(s) and oscilloscope. A typical test setup is shown in Figure 2.

#### **Decoupling Capacitors**

Each power supply is decoupled with a  $10\mu F$  ceramic capacitor in parallel with a  $0.1\mu F$  ceramic capacitor, which are placed close to the U1  $V_{DDA}$  or  $V_{DDB}$  pin.

### Termination

Each input and output has an unpopulated 0603 SMT resistor (RA1-RA4, RB1-RB4) and an unpopulated 0603 SMT capacitor (CA1-CA4, CB1-CB4) to GND\_ to allow termination based on customer requirements.

#### **Shunt Positions**

Jumpers J1 and J2 are installed between the external power supplies and U1 power supply pins to allow supply current measurement. Uninstall the J1 and J2 shunts and connect current meters on both side A and side B to measure the MAX14430–MAX14432 supply current.

Jumper ENA is provided to enable or disable the side A of the isolator channels. To enable the devices with active-high enable pin on the side A (MAX1443\_B/C/E/F), connect the ENA shunt to  $V_{DDA}$ . To enable the devices with active-low enable pin on the side A (MAX14431R/S/U/V), connect the ENA shunt to GNDA. The side A outputs are high-impedance when disabled.

Jumper ENB is provided to enable or disable the side B of the isolator channels. Connect the ENB shunt to  $V_{DDB}$  to enable the side B channels, or connect to GNDB to disable the side B channels. The side B outputs are high-impedance when disabled. See Table 2 for all shunt positions.

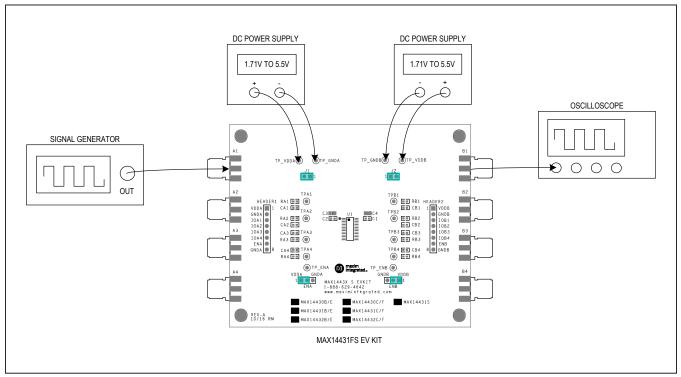


Figure 2. MAX14431FS EV Kit Typical Test Setup

# **Ordering Information**

PART	ТҮРЕ
MAX14430FSEVKIT#*	EV kit with installed MAX14430FASE+
MAX14431FSEVKIT#*	EV kit with installed MAX14431FASE+
MAX14432FSEVKIT#	EV kit with installed MAX14432FASE+

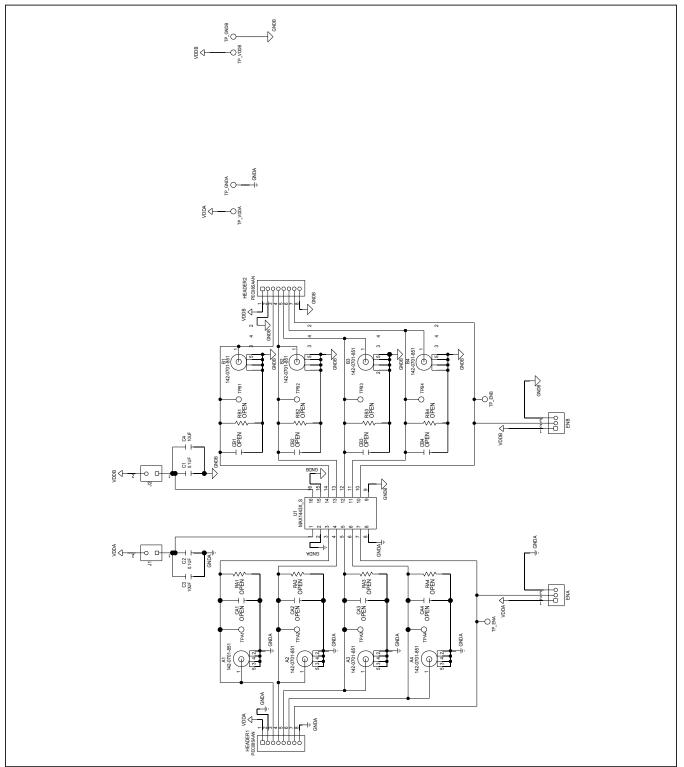
#Denotes RoHS compliant.

\*Future Product—Contact factory for availability.

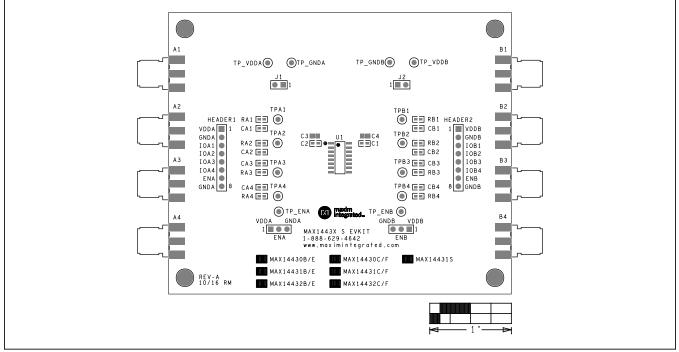
## MAX14430–MAX14432 EV Kit Bill of Materials

		DNI/					
ITEM	REF_DES	DNP	QTY	MFG PART #	MFG	VALUE	DESCRIPTION
							CONNECTOR; END LAUNCH JACK
					JOHNSON		RECEPTACLE; BOARDMOUNT; STRAIGHT
1	A1-A4, B1-B4	-	8	142-0701-851	COMPONENTS	142-0701-851	THROUGH; 2PINS;
				ECJ-1VB1H104K;			
				GRM188R71H104KA;			
				CGJ3E2X7R1H104K080AA:			
				C1608X7R1H104K080AA:	PANASONIC:		CAPACITOR; SMT (0603); CERAMIC CHIP;
				CL10B104KB8NFN:	MURATA: TDK:		0.1UF: 50V: TOL=10%: TG=-55 DEGC TO +125
2	C1. C2	_		CL10B104KB8NNN	SAMSUNG	0.1UF	DEGC: TC=X7R:
	01, 02	_	2		0/1000100	0.101	CAPACITOR; SMT (0805); CERAMIC CHIP;
					SAMSUNG		10UF; 16V; TOL=10%; TG=-55 DEGC TO +125
3	C3, C4	-	2	CL21B106KOQNNN	ELECTRONICS	10UF	DEGC; TC=X7R
	· · · ·						CONNECTOR; MALE; THROUGH HOLE;
4	ENA, ENB	-	2	PEC03SAAN	SULLINS	PEC03SAAN	BREAKAWAY; STRAIGHT; 3PINS
					SULLINS		CONNECTOR; MALE; THROUGH HOLE; .100IN
	HEADER1,				ELECTRONICS		CONTACT CENTER; MALE BREAKAWAY
5	HEADER2	-	2	PEC08SAAN	CORP.	PEC08SAAN	HEADER ; STRAIGHT; 8PINS
							CONNECTOR; MALE; THROUGH HOLE;
6	J1, J2	-	2	PEC02SAAN	SULLINS	PEC02SAAN	BREAKAWAY; STRAIGHT; 2PINS
							KIT; ASSY-STANDOFF 3/8IN; 1PC.
				EVKIT STANDOFF 4-		EVKIT STAND	STANDOFF/FEM/HEX/4-40IN/(3/8IN)/NYLON;
7	MTH1-MTH4	_		40 3/8	2	_	1PC. SCREW/SLOT/PAN/4-40IN/(3/8IN)/NYLON
	1011111-101111-+	-	т	+0_0/0		011_1-0/0	
							TEST POINT; JUMPER; STR; TOTAL
					SULLINS		LENGTH=0.256IN; BLACK; INSULATION=PBT
					ELECTRONICS		CONTACT=PHOSPHOR BRONZE; COPPER
8	SU1-SU4	-	4	STC02SYAN	CORP.	STC02SYAN	PLATED TIN OVERALL
							TEST POINT; PIN DIA=0.1IN; TOTAL
							LENGTH=0.3IN; BOARD HOLE=0.04IN;
	TPA1-TPA4, TPB1-						YELLOW; PHOSPHOR BRONZE WIRE SILVER
9	TPB4	-	8	5004	KEYSTONE	N/A	PLATE FINISH;
							TEST POINT; PIN DIA=0.1IN; TOTAL
							LENGTH=0.3IN: BOARD HOLE=0.04IN: WHITE:
10	TP ENA, TP ENB		2	5002	KEYSTONE	N/A	PHOSPHOR BRONZE WIRE SILVER;
10	TI_EINA, IF_EIND	<b>[</b>	2	5002	NE 13TONE	111/71	THOSE HOR DRUNZE WIRE SILVER,

## MAX14430–MAX14432 EV Kit Schematic

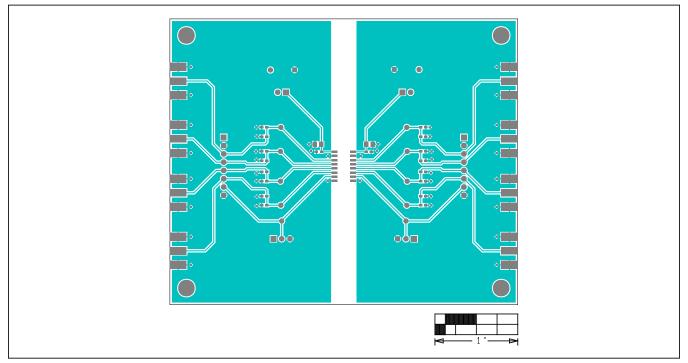


## Evaluates: MAX14430–MAX14432

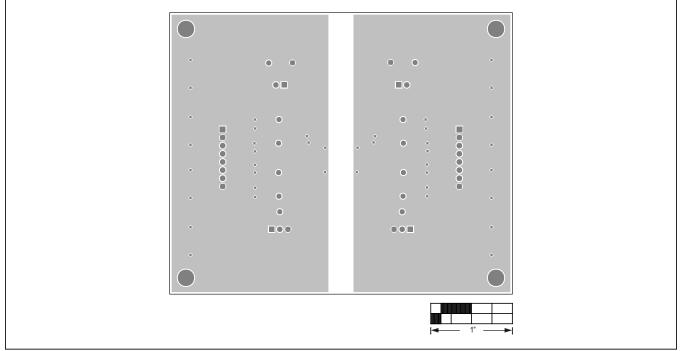


## MAX14430–MAX14432 EV Kit PCB Layout Diagrams

MAX14430–MAX14432 EV Kit—Top Silkscreen

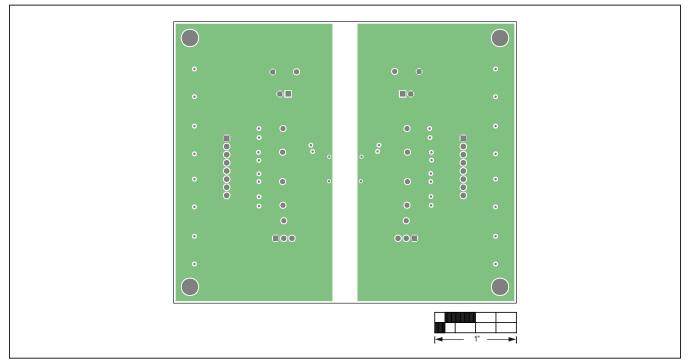


MAX14430–MAX14432 EV Kit—Top

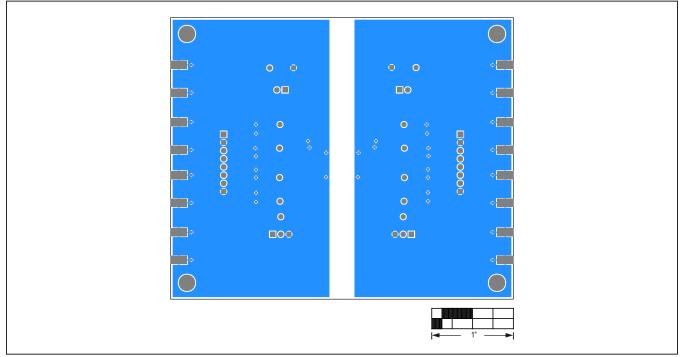


# MAX14430–MAX14432 EV Kit PCB Layout Diagrams (continued)

MAX14430-MAX14432 EV Kit-L2 GND



MAX14430–MAX14432 EV Kit—L3 PWR



# MAX14430–MAX14432 EV Kit PCB Layout Diagrams (continued)

MAX14430–MAX14432 EV Kit—Bottom